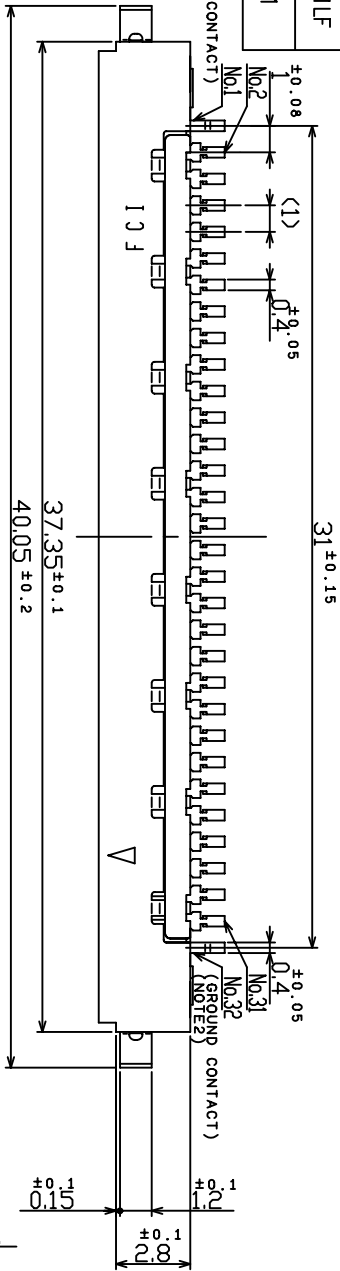
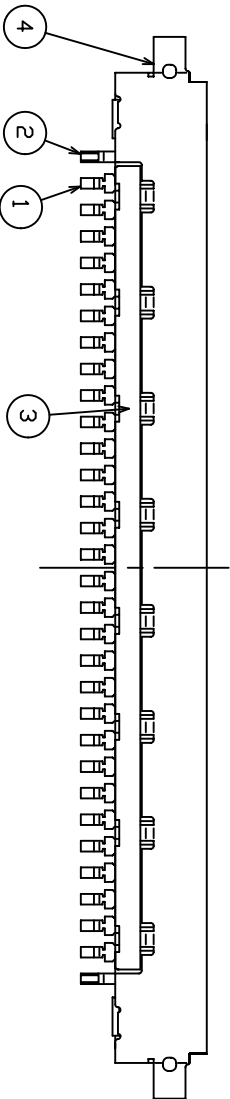
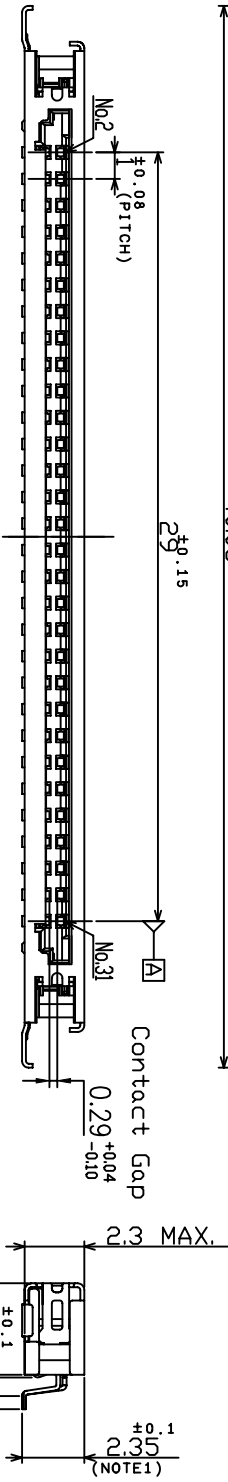


PRODUCT NO.
10041195-001LF
10041195-001



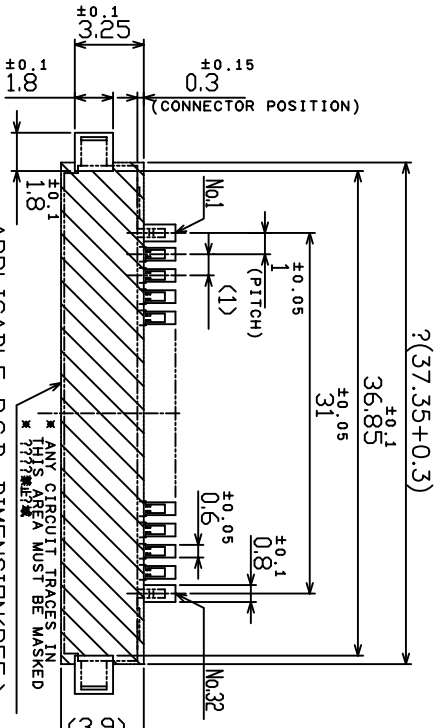
REV	DESCRIPTION	ECN	BY	DATE
A	RELEASED	J05-0016	M.H	1/14/05
B	RELEASED	T05-0184	S.L.H	08/17/05
C	REVISED	T05-0299	S.L.H	12/28/05
D	REVISED	T06-0090	A.C	5/05/06
E	REVISED	T06-0102	A.C	5/22/06
F	REVISED	T07-1112	A.C	7/09/07
G	REVISED	T07-1135	A.C	10/12/07
H	REVISED	T08-1129	S.L.H	07/07/08

NOTE1: COPLANARITY BETWEEN TERMINAL AND HOLD DOWN OF SHELL SHOULD BE 0.08mm MAX.
2. TERMINALS No.1 and No.32 ARE APPROPRIATE FOR GROUND CONTACTS.



3. THE PRODUCT MEETS THE EUROPEAN UNION DIRECTIVE AS DESCRIBED IN GS-22-008.
4. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 5 SECONDS IN A CONVECTION, IR OR VAPOR PHASE REFLOW OVEN.
5. SPEC : PRODUCT SPEC: GS-12-293
PACKING SPEC: GS-14-988

NO	DESCRIPTION	Quantity (pcs)	Material	FINISH	REMARKS
1	Signal Contact	30	COPPER ALLOY	CONTACT AREA : Au 0.2um (8u")MIN. OVER Ni 1.5um (60u")MIN.	SOLDER AREA : Au FLASH. OVER Ni 1.5um (60u")MIN.
2	Ground Contact	1	COPPER ALLOY	Sn 2.0um (80u")MIN. OVER Ni 1.27um (50u")MIN.	UL94 V-0
3	Insulator	1	HEAT RESISTING PLASTIC		
4	Shell	1	STAINLESS STEEL	Sn 2.0um (80u")MIN. OVER Ni 1.27um (50u")MIN.	



APPLICABLE P.C.B. DIMENSION(REF.)

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SHEET INDEX	ISSUE	H	H	H	MAT	DR	DATE	CUSTOMER	UNIT
XX	±0.1	±0.1	±0.1	±0.1	SEE NOTE	STERLING LIN	12/28/05	Board Connector for LCD (On Type) Panels	MM
XX	±0.1	±0.1	±0.1	±0.1	SEE NOTE	STERLING LIN	12/28/05	Board Connector for LCD (On Type) Panels	MM
XX	±0.1	±0.1	±0.1	±0.1	SEE NOTE	STERLING LIN	12/28/05	Board Connector for LCD (On Type) Panels	MM



TITLE	SIZE	DWG. NO.	REV	SHEET
Standard Looking Type LVDS Board Connector for LCD (On Type) Panels	2/1	B	G	10F3

